ACCELERATE®HD HIGH-DENSITY SLIM BODY ARRAYS (0.635 mm) .025" PITCH

FEATURES & BENEFITS

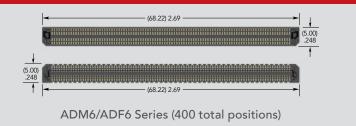
- Up to 240 positions in 4-row design (400 positions in development)
- Low-profile 5 mm stack heights
- Slim 5 mm width body design
- Edge Rate[®] contact system optimized for signal integrity performance
- Open-pin-field for grounding and routing flexibility
- PCIe[®] 5.0 capable
- Compatible with mPower[®] (UMPT/UMPS) for a power signal solution





Solder ball technology for simplified processing

HIGHER DENSITY THAN PREVIOUS GENERATION STRIPS



KEY SPECIFICATIONS

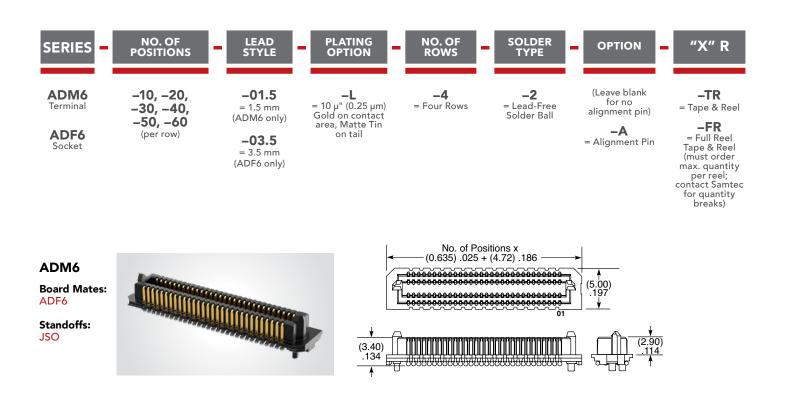
РІТСН	TOTAL POSITIONS	INSULATOR MATERIAL	CONTACT MATERIAL	PLATING	OPERATING TEMP RANGE	CURRENT RATING	WORKING VOLTAGE	LEAD-FREE SOLDERABLE
(0.635 mm) .025"	40 - 240	Black LCP	Copper Alloy	Au or Sn over 50 μ" (1.27 μm) Ni	-55 ℃ to +125 ℃	1.34 A per pin (4 pins powered)	Testing now	Yes

samtec.com/AcceleRateHD

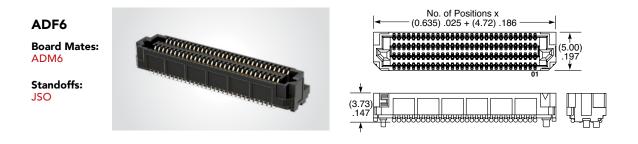
Unless otherwise approved in writing by Samtec, all parts and components are designed and built according to Samtec's specifications which are subject to change without notice.



(0.635 mm) .025" PITCH • SLIM BODY OPEN-PIN-FIELD ARRAYS



	MATED HEIGHTS *		
	ADF6	ADM6 LEAD STYLE	
View complete specifications at: samtec.com?ADM6	LEAD STYLE	-01.5	
	-03.5	(5 mm) .197"	
	* Processing cond	ditions will affect mated height.	



Notes: Some sizes, styles and options are non-standard, non-returnable

View complete specifications at: samtec.com?ADF6 samtec.com/AcceleRateHD

F-221 (Rev 14SEP21)

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Mouser Electronics

Authorized Distributor

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Samtec: ADF6-20-03.5-L-4-2-A-TR